

RoHS

COMPLIANT HALOGEN

FREE

Vishay Siliconix

P-Channel 20 V (D-S) MOSFET

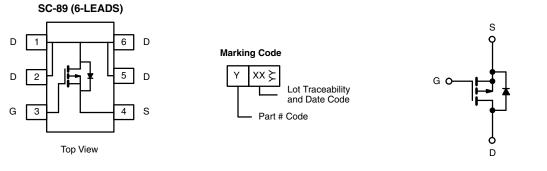
PRODU	RODUCT SUMMARY				
V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)	Q _g (Typ.)		
- 20	0.184 at V _{GS} = - 4.5 V	- 0.94	4.23		
- 20	0.268 at V _{GS} = - 2.5 V	- 0.78	4.20		

FEATURES

- Halogen-free According to IEC 61249-2-21
 Definition
- TrenchFET[®] Power MOSFET
- 100 % Rg Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

• Load Switch for Portable Devices



Ordering Information: Si1069X-T1-GE3 (Lead (Pb)-free and Halogen-free)

P-Channel MOSFET

ABSOLUTE MAXIMUM RATING	S (T _A = 25 °C, unle	ess otherwise	e noted)		
Parameter		Symbol	Limit	Unit	
Drain-Source Voltage		V _{DS}	- 20	- V	
Gate-Source Voltage		V _{GS}	± 12		
Continuous Drain Current ($T_{1} = 150 \ ^{\circ}C$)	T _A = 25 °C	1-	- 0.94 ^{b, c}		
	T _A = 70 °C	I _D	- 0.75 ^{b, c}	A	
Pulsed Drain Current		I _{DM}	- 8		
Continuous Source-Drain Diode Current	T _A = 25 °C	۱ _S	- 0.2 ^{b, c}	-	
	T _A = 25 °C	P _D 0.236 ^{b, c}		w	
Maximum Power Dissipation ^a	T _A = 70 °C	·D	0.151 ^{b, c}		
Operating Junction and Storage Temperature R	ange	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum hunstion to Archienta b	t ≤ 5 s	R _{thJA}	440	530	°C/W
Maximum Junction-to-Ambient ^{a, b}	Steady State	' 'thJA	540	650	0/10

Notes:

a. Based on T_A = 25 °C.

b. Surface mounted on 1" x 1" FR4 board.

c. t = 5 s.

Si1069X

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = -250 \mu A$	- 20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	- Ι _D = - 250 μΑ		- 16.7		m\//°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	η _D = - 250 μΑ		2.95		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = -250 \ \mu A$	- 0.6		- 1.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 12 V$			± 100	nA	
Zara Cata Valtaga Drain Current	I	$V_{DS} = -20 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			- 1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} = - 20 V, V_{GS} = 0 V, T_{J} = 85 °C			- 10	μΑ	
On-State Drain Current ^a	I _{D(on)}	V_{DS} = \geq 5 V, V_{GS} = - 4.5 V	- 8			А	
	D	$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -0.94 \text{ A}$		0.153	0.184		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V_{GS} = - 2.5 V, I _D = - 0.78 A		0.218	0.268	Ω	
Forward Transconductance	9 _{fs}	V _{DS} = - 10 V, I _D = - 0.94 A		4		S	
Dynamic ^b		· · · · · · · · · · · · · · · · · · ·			•	•	
Input Capacitance	C _{iss}			308			
Output Capacitance	C _{oss}	$V_{DS} = -10 V$, $V_{GS} = 0 V$, f = 1 MHz		78		pF	
Reverse Transfer Capacitance	C _{rss}			59			
Tatal Cata Charge	0	$V_{DS} = -10 \text{ V}, \text{ V}_{GS} = -5 \text{ V}, \text{ I}_{D} = -0.94 \text{ A}$		4.57	6.86		
Total Gate Charge	Q_g			4.23	6.35		
Gate-Source Charge	Q _{gs}	$V_{DS} = -10 V, V_{GS} = -4.5 V, I_{D} = -0.94 A$		0.71		nC	
Gate-Drain Charge	Q _{gd}			1.67			
Gate Resistance	Rg	f = 1 MHz		9	13.5	Ω	
Turn-On Delay Time	t _{d(on)}			19	28.5		
Rise Time	t _r	V_{DD} = - 10 V, R _L = 13.3 Ω		31	47		
Turn-Off DelayTime	t _{d(off)}	$\text{I}_\text{D}\cong$ - 0.75 A, V_GEN = - 4.5 V, R_g = 1 Ω		23	34.5	ns	
Fall Time	t _f			7	10.5		
Drain-Source Body Diode Characteris	stics	•			•		
Pulse Diode Forward Current ^a	I _{SM}				8	Α	
Body Diode Voltage	V _{SD}	I _S = - 0.64 A		- 0.8	- 1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			19	28.5	nC	
Body Diode Reverse Recovery Charge	Q _{rr}			6.65	10		
Reverse Recovery Fall Time	t _a	l _F = - 0.64 A, dl/dt = 100 A/μs		7		ns	
Reverse Recovery Rise Time	t _b	1		12		—	

Notes:

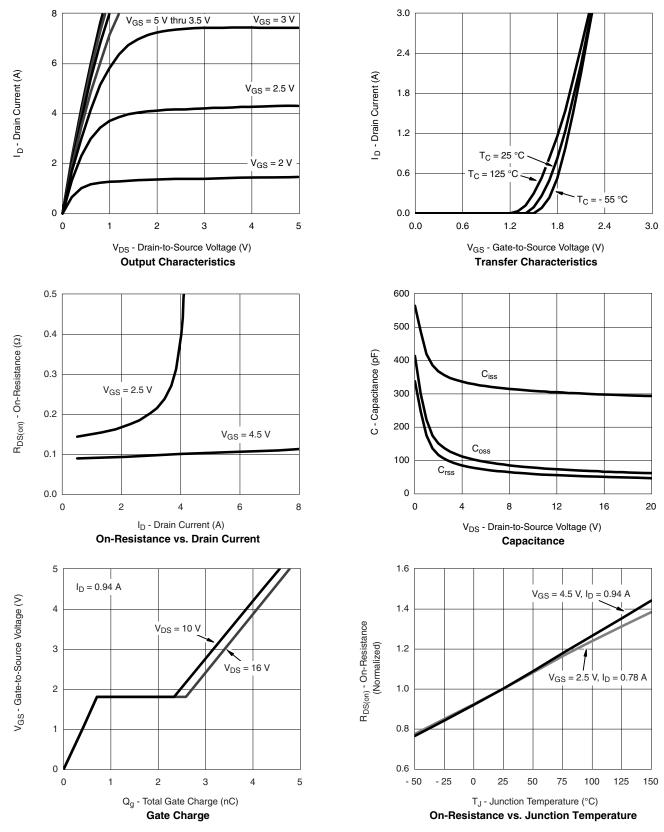
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



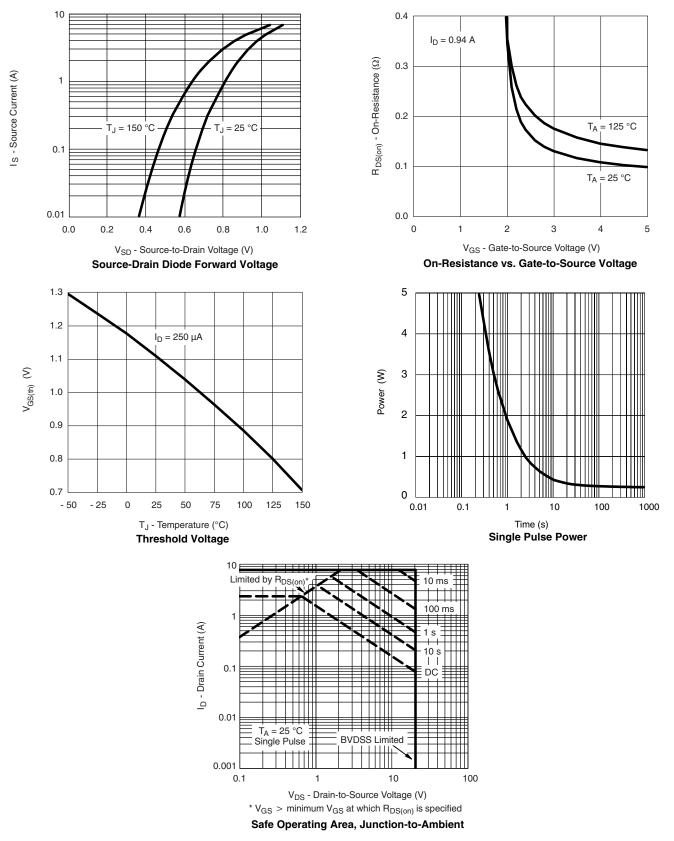
Document Number: 70442 S19-0207-Rev. D, 04-Mar-2019

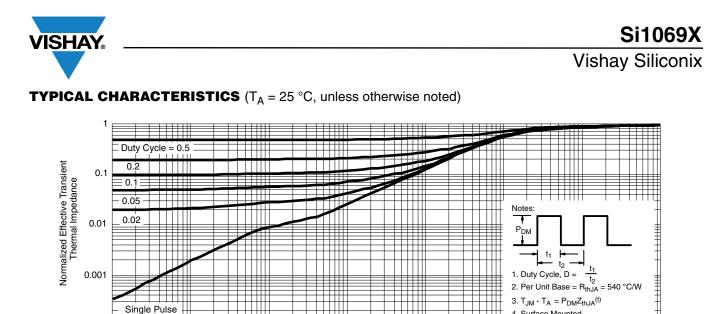
Si1069X

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)





10-1

1

Square Wave Pulse Duration (s) Normalized Thermal Transient Impedance, Junction-to-Ambient

4. Surface Mounted

10

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100

1000

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?70442.

10⁻³

10-2

0.0001 10-4



Vishay Siliconix

SC-89 6-Leads (SOT-563F)



Notes

- 1. Dimensions in millimeters.
- Dimension D does not include mold flash, protrusions or gate burrs. Mold flush, protrusions or gate burrs shall not exceed 0.15 mm per dimension E1 does not include interlead flash or protrusion, interlead flash or protrusion shall not exceed 0.15 mm per side.
- Dimensions D and E1 are determined at the outmost extremes of the plastic body exclusive of mold flash, the bar burrs, gate burrs and interlead flash, but including any mismatch between the top and the bottom of the plastic body.

A Datums A, B and D to be determined 0.10 mm from the lead tip.

 \triangle Terminal numbers are shown for reference only.

These dimensions apply to the flat section of the lead between 0.08 mm and 0.15 mm from the lead tip.









DIM.	MILLIMETERS				
	MIN.	NOM.	MAX.		
А	0.56	0.58	0.60		
A1	0	0.02	0.10		
b	0.15	0.22	0.30		
С	0.10	0.14	0.18		
D	1.50	1.60	1.70		
E	1.50	1.60	1.70		
E1	1.15	1.20	1.25		
е	0.45	0.50	0.55		
e1	0.95	1.00	1.05		
L	0.25	0.35	0.50		
L1	0.10	0.20	0.30		
C14-0439-Rev DWG: 5880	v. C, 11-Aug-14				

Revision: 11-Aug-14

1 For technical questions, contact: <u>analogswitchtechsupport@vishay.com</u> Document Number: 71612

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Application Note 826

Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR SC-89: 6-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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